

20V P-Channel Enhancement Mode MOSFET

Description

The PECN2301A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications.

General Features

- ◆ $V_{DS} = -20V$, $I_D = -1.4A$
 $R_{DS(ON)}(Typ.) = 110m\Omega$ @ $V_{GS} = -2.5V$
 $R_{DS(ON)}(Typ.) = 90m\Omega$ @ $V_{GS} = -4.5V$
- ◆ High power and current handing capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

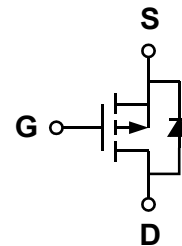
- ◆ PWM applications
- ◆ Load switch

Package

- ◆ SOT-323

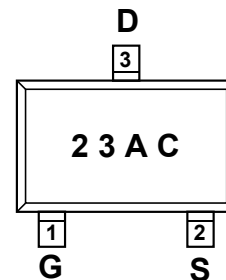


Schematic diagram



Marking and pin assignment

SOT-323
(TOP VIEW)



23A----PECN2301A

C----- Package Information

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN2301AJ R-G	-55°C to +150°C	SOT-323	3000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit	
Drain-source voltage	V_{DS}	-20	V	
Gate-source voltage	V_{GS}	± 12	V	
Drain current-continuous @ $T_j = 125^\circ C^a$ -pulse d^c	I_D	-1.4	A	
	I_{DM}	-5.6	A	
Maximum power dissipation	P_D	$T_a = 25^\circ C$	350	mW
		Derate above 25°C	2.8	mW/°C
Operating junction Temperature range	T_j	-55—150	°C	
Typical Thermal resistance — Junction to Ambient ^b	$R_{\theta JA}$	357	°C/W	

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V$	-	-	-1	μA
Gate-body leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$	-	-	± 100	nA
ON Characteristics						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.65	-1.2	V
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-1.4A$	-	90	125	m Ω
		$V_{GS}=-2.5V, I_D=-1.4A$	-	110	140	
Dynamic Characteristics						
IPECNut capacitance	C_{ISS}	$V_{DS}=-10V, V_{GS}=0V$ $f=1.0MHz$	-	416	-	pF
Output capacitance	C_{OSS}		-	43	-	
Reverse transfer capacitance	C_{RSS}		-	32	-	
Switching Characteristics						
Turn-on delay time	$t_{D(ON)}$	$V_{DD}=-10V$ $I_D=-1.4A$ $V_{GEN}=-4.5V$ $R_{GEN}=-6\Omega$	-	3.9	-	ns
Rise time	t_r		-	27	-	
Turn-off delay time	$t_{D(OFF)}$		-	78	-	
Fall time	t_f		-	45	-	
Total gate charge	Q_g	$V_{DS}=-10V, I_D=-1.4A$ $V_{GS}=-4.5V$	-	5.4	-	nC
Gate-source charge	Q_{gs}		-	0.7	-	
Gate-drain charge	Q_{gd}		-	1.4	-	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode forward voltage	V_{SD}	$V_{GS}=0V, I_S=-1A$	-	-0.81	-1.2	V

Notes:

- surface mounted on FR4 board, $t \leq 10\text{sec}$
- pulse test: pulse width $\leq 300\mu s$, duty $\leq 2\%$
- guaranteed by design, not subject to production testing

Typical Performance Characteristics

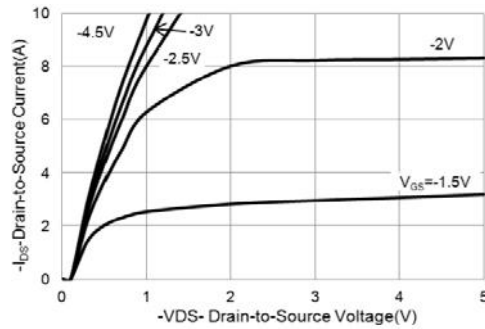


Fig 1: On-Region Characteristics

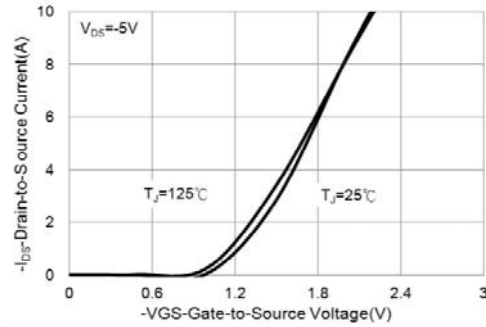


Figure 2: Transfer Characteristics

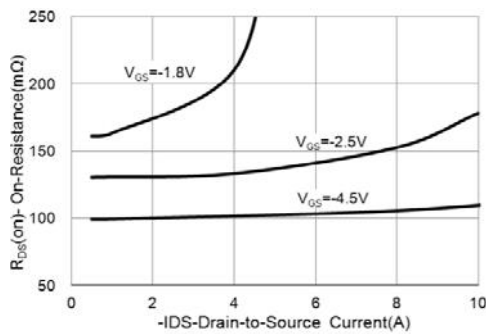


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

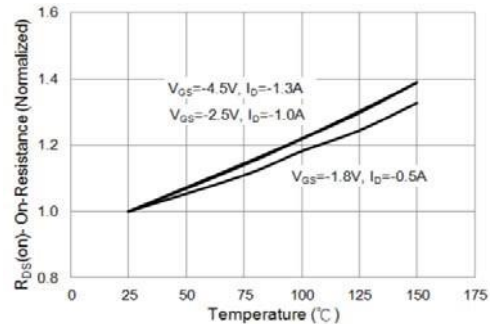


Figure 4: On-Resistance vs. Junction Temperature

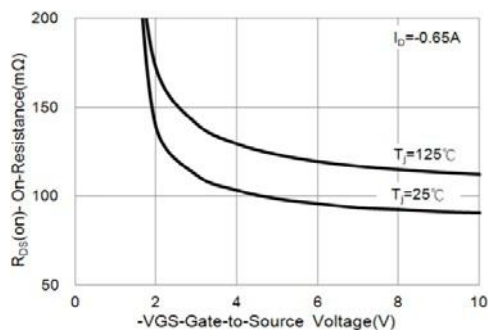


Figure 5: On-Resistance vs. Gate-Source Voltage

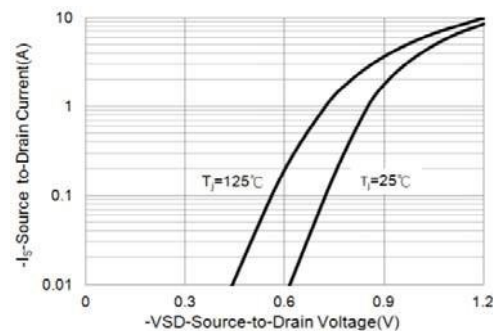
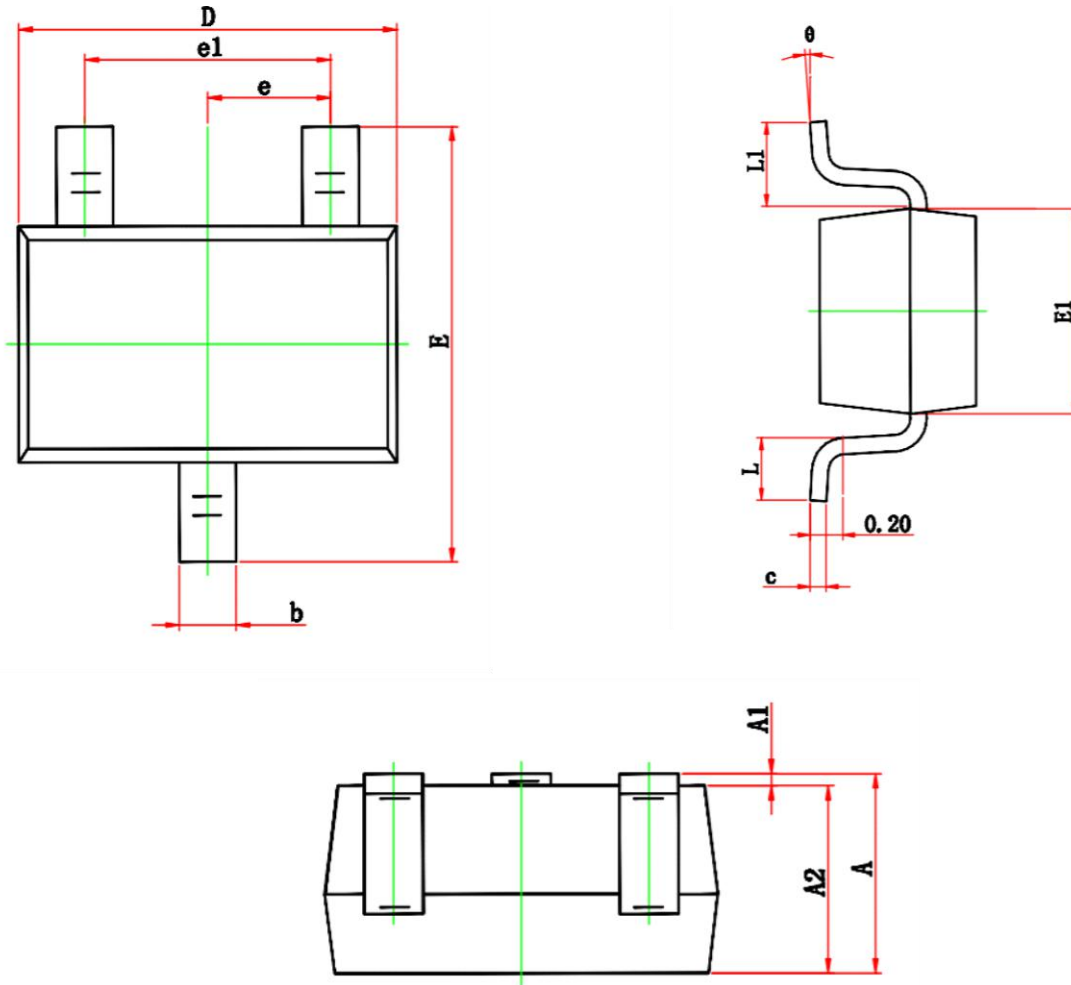


Figure 6: Body-Diode Characteristics

Package Information

- SOT-323



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	2.150	2.450	0.085	0.096
E1	1.150	1.350	0.045	0.053
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.260	0.460	0.010	0.018
L1	0.525 REF.		0.021 REF.	
θ	0°	8°	0°	8°